### MODEL NO: VR162N11CUP-10C3M-L16R/Ф6.35/M8-6.5/TIN/GN

## P/N: <u>R-VSN-3MC-SS</u>



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#### MECHANICAL

- 1. Overall rotation angle :  $300^{\circ} \pm 5^{\circ}$ .
- 2. Without centre detent : **20-300** gf.cm.
- 3. Shaft end stop strength : 5 kgf.cm MIN.
- 4. Starting torque : 200 gf.cm. MAX.
- 5. Resistance to soldering heat :

After soldering (Less than 300  $^{\circ}$ C and quicker than 3 seconds ) there shall be no evidence of poor contact between resistance element and terminals ,or any physical damages as a result of the test.

6. Play of shaft (wobble) :

The resistor shall be mounted by soldering the mounting legs on the panel, and a side thrust of 250 gf.cm at the shaft shall be applied, then the total play (wobble) of the shaft shall not exceed the following criterion according to JIS C6443:

0.7XL/30 mm P-P Max(different resistors will have different criteria)

Where L is the length of the shaft .

7. Eccentricity of shaft :

The eccentricity of the root of shaft shall not exceed 0.35mm against the center of the mounting position. 8. Robustness of shaft against end thrust :

- The shaft shall withstand against end thrust of not less than 5 kgf for 3 seconds.
- 9. Robustness of shaft against side thrust :

The shaft shall withststand against side thrust of not less than 4 kgf.cm for 3 seconds on the shaft at right angles to the axis of the shaft after mounting the resistor by soldering.

 $\triangle$ 10. Bushing nut tightening strength :(where threaded bushing exists will be applied , where no bushing resistors will be deleted)

Tightening torque to be no greater than 7 kgf.cm.

\*Pay attention otherwise the strength may not be measured. CUATION

(chassis mounting)

In case you are using this part fastening to the chassis using a nut, excessive tightening torque may deteriorate the rotary contact performance or brake the threads and pay due attention when determining the tightening torque. (The above operation notes are quoted from the "precaution

and Guideline of potentiometer for Electrical Devices", which

is a technical report issued by the Electronic Industries Association

of Japan (in July 1994))for details, refer to the original technical report.

#### 11. Push pull strength :

- (a). Push pull strength (applicable to deformation of shaft only) No demages with an application of push pull force 10Kgf-cm for 10 second. (max.)
- (b). Push pull strength (applicable to wiper only) No demages with an application of push pull force=/less 5Kgf-cm for=/less 5 seconds.
- 12. ENDURANCE

Rotational life : **15,000** cycles min.

## NOTE

- 1. The other items above-mentioned shall meet or exceed JIS C6443.
- 2. Any special specifications that exceed JIS C6443 shall be discussed with the manufacturer for revisions subject to acceptance of the manufacturer.



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1.					
	1-1. Application: This specification is applied to poteniometers used for electronic				
	equipment.				
	1-2. Standard atmospheric conditions				
	Unless otherwise specified, the standard range of atmospheric conditions				
	Ambient temperature $15^{\circ}$ to $25^{\circ}$				
	Ambrent temperature : 15 C to 55 C				
	$\begin{array}{c} \text{Relative number of } \\ \text{Airs and served} $				
	Air pressure : $\delta \delta$ kpa to 100 kpa				
	1-3. Operating temperature range : -10 C to +70 C				
	1-4. Storage temperature range : -30 C to +70 C				
	1-5. Suggested storage period : About 6 months				
2.	2. Construction				
	2-1 Dimensions				
	Refer to attached drawing				
3.	Soldering conditions				
	3-1.Manual soldering :				
	Temperature of soldering iron $: 300^{\circ}$ C or less.				
	Application time of soldering iron :within 3s.				
	3-2.Dip Soldering				
	Printed wiring board: Single-sided copper clad laminate board with				
	thickness of 1.6mm.				
	Flux:				
	• Specific gravity: 0.82 or more.				
	• Flux shall be applied to the board using a bubble foaming type fluxer.				
	• The board shall be soaked in the flux bubble only to the middle of its thickness.				
	• Flux shall not come into contact with the component side surface.				
	Preheating:				
	• Surface temperature of board: $100^{\circ}$ C or less.				
	• Preheating time : Within 2 min.				
	Soldering:				
	• Solder temperature : $260^{\circ}$ C less.				
	• Immersion time: Within 3 s.				
4.	Apply the above solderig process for 1 or 2 times.				

5. To be careful for using this unit in such violent gas atmospheric condition as ammonia, amine, alkaline aqueous solution, aromatic hydrocarbon, keton, ester alkyl hydrocarbon, etc.

2010-	APPROVAL BY CHECK BY MADE	◆帝亚电子股份有限公司	NUT $NUT$ $M8*0.75$ $6.$
-9-27 -9-27 SCALE:1.8/1	BY NO:	MODEL:RA16N11(VR162	12.8 12.7
	- CUSTOMER CONFIRM (客户认可签章)	N11CUP)-L16R/46.35/M8-6.5	Mounting surface UNDER 10 ±0.3 OVER 100 ±0.8

